Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Vishay/Siliconix IRFD310

For any questions, you can email us directly: sales@integrated-circuit.com



Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of IRFD310 - MOSFET N-CH 400V 350MA 4-DIP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



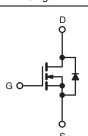
IRFD310, SiHFD310

Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	400			
R _{DS(on)} (Ω)	V _{GS} = 10 V 3.6			
Q _g (Max.) (nC)	17			
Q _{gs} (nC)	3.4			
Q _{gd} (nC)	8.5	i		
Configuration	Sing	le		



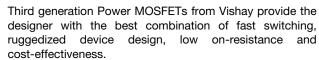


N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION



The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serveres as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD310PbF
Lead (i b)-liee	SiHFD310-E3
SnPb	IRFD310
Sill b	SiHFD310

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	400	V		
Gate-Source Voltage		V_{GS}	± 20			
Continuous Drain Current	V _{GS} at 10 V	T _A = 25 °C	-	0.35		
Continuous Drain Current	V _{GS} at 10 V	T _A = 100 °C	l _D	0.22	Α	
Pulsed Drain Current ^a			I _{DM}	2.8		
Linear Derating Factor			0.0083	W/°C		
Single Pulse Avalanche Energy ^b		E_{AS}	46	mJ		
Avalanche Current ^a		I _{AR}	0.35	Α		
Repetitive Avalanche Energy ^a		E _{AR}	0.10	mJ		
Maximum Power Dissipation	T _A =	25 °C	P_D	1.0	W	
Peak Diode Recovery dV/dt ^c		dV/dt	4.0	V/ns		
Operating Junction and Storage Temperature Range	e		T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d]	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 41 \, \text{mH}$, $R_g = 25 \, \Omega$, $I_{AS} = 1.4 \, \text{A}$ (see fig. 12).
- c. $I_{SD} \le 2.0$ A, $dI/dt \le 40$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

S10-2463-Rev. C, 08-Nov-10

Document Number: 91133

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of IRFD310 - MOSFET N-CH 400V 350MA 4-DIP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IRFD310, SiHFD310

Vishay Siliconix



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	120	°C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	400	-	-	V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	Reference	e to 25 °C, I _D = 1 mA	-	0.47	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
Zana Oata Waltana Busin Ouwant		V _{DS} = 400 V, V _{GS} = 0 V		-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 320 V	V, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 0.21 A ^b	-	-	3.6	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 1.2 A	1.0	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 V$,		-	170	-	pF
Output Capacitance	Coss	1	$V_{DS} = 25 \text{ V},$		34	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	6.3	-	
Total Gate Charge	Qg		I _D = 2.0 A, V _{DS} = 320 V, see fig. 6 and 13 ^b	-	-	17	nC
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V		-	-	3.4	
Gate-Drain Charge	Q _{gd}		ooo ng. o ana 10	-	-	8.5	•
Turn-On Delay Time	t _{d(on)}			-	8.0	-	
Rise Time	t _r	V _{DD} -	200 V, I _D = 2.0 A,	-	9.9	-	
Turn-Off Delay Time	t _{d(off)}		$R_D = 95 \Omega$, see fig. 10^b	-	21	-	ns
Fall Time	t _f			-	11	-	1
Internal Drain Inductance	L _D	6 mm (0.25")	Between lead, 6 mm (0.25") from		4.0	-	- nH
Internal Source Inductance	L _S	package and center of die contact		-	6.0	-	1117
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		ı	-	0.35	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	2.8	
Body Diode Voltage	V_{SD}	T _J = 25 °C	$I_S = 0.35 \text{ A}, V_{GS} = 0 \text{ V}^b$	-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C 1	_0.0 A dI/d+ 100 A/:-b	-	240	540	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 2.0 \text{A}, dI/dt = 100 \text{A/} \mu \text{s}^{\text{b}}$		-	0.85	1.6	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	y L _S and	Ln)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.





Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

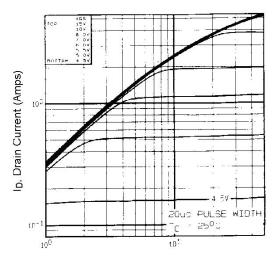


Fig. 1 - Typical Output Characteristics, T_A = 25 °C

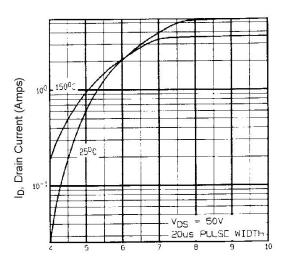


Fig. 3 - Typical Transfer Characteristics

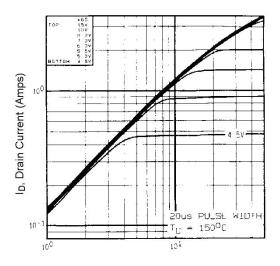


Fig. 2 - Typical Output Characteristics, T_A = 150 °C

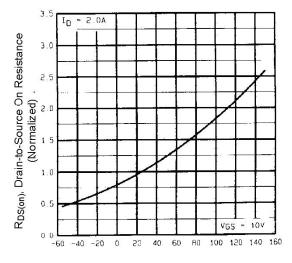


Fig. 4 - Normalized On-Resistance vs. Temperature



Vishay Siliconix



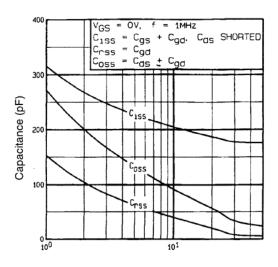


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

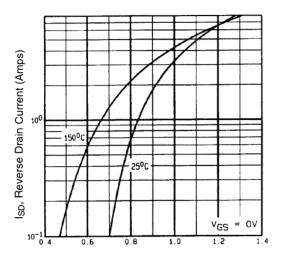


Fig. 7 - Typical Source-Drain Diode Forward Voltage

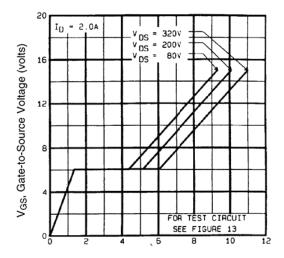


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

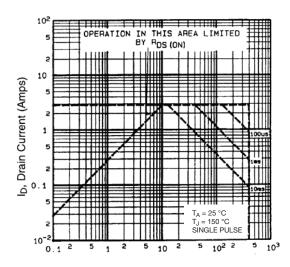


Fig. 8 - Maximum Safe Operating Area

www.vishay.com





Vishay Siliconix

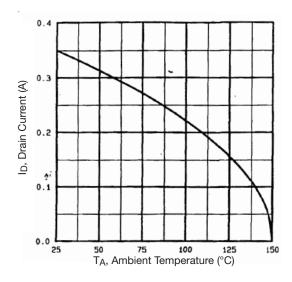


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

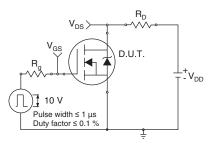


Fig. 10a - Switching Time Test Circuit

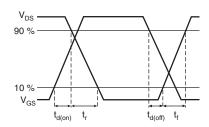


Fig. 10b - Switching Time Waveforms

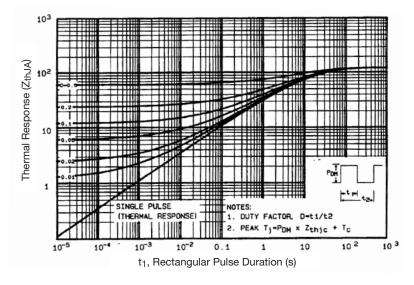


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

Document Number: 91133 S10-2463-Rev. C, 08-Nov-10 Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IRFD310, SiHFD310

Vishay Siliconix



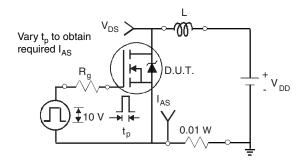


Fig. 12a - Unclamped Inductive Test Circuit

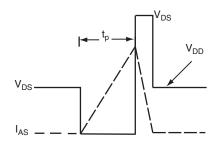


Fig. 12b - Unclamped Inductive Waveforms

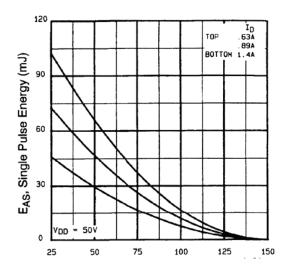


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

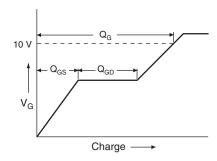


Fig. 13a - Basic Gate Charge Waveform

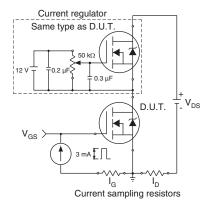


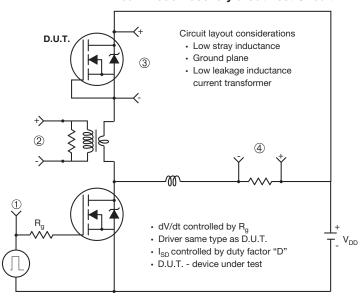
Fig. 13b - Gate Charge Test Circuit





Vishay Siliconix

Peak Diode Recovery dV/dt Test Circuit



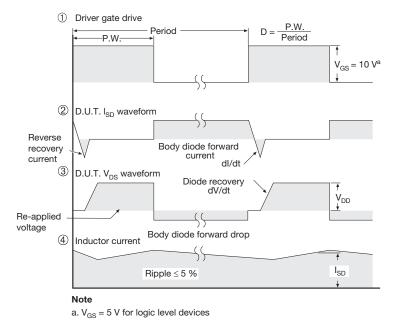


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91133.

Document Number: 91133 www.vishay.com S10-2463-Rev. C, 08-Nov-10 7

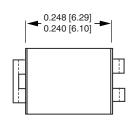


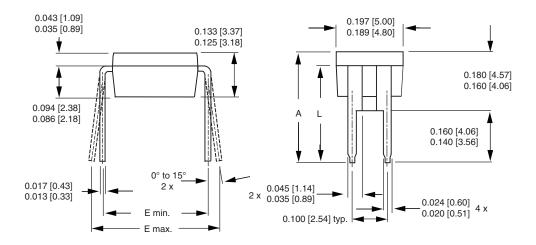


Package Information

Vishay Siliconix

HVM DIP (High voltage)





	INCHES		MILLIMETERS	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.

Document Number: 91361 www.vishay.com
Revision: 06-Sep-10 1



Distributor of Vishay/Siliconix: Excellent Integrated System Limited

Datasheet of IRFD310 - MOSFET N-CH 400V 350MA 4-DIP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



www.vishay.com

Legal Disclaimer Notice

Vishav

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000